

HAT2129H

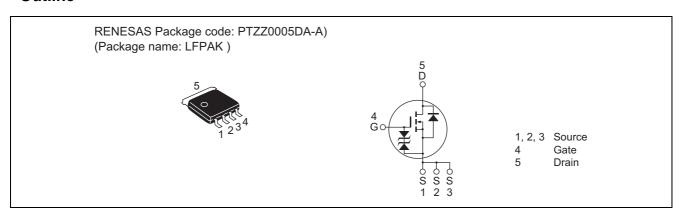
Silicon N Channel Power MOS FET Power Switching

REJ03G0049-0500 Rev.5.00 Sep 20, 2005

Features

- Capable of 7 V gate drive
- Low drive current
- High density mounting
- Low on-resistance $R_{DS(on)} = 6 \ m\Omega \ typ. \ (at \ V_{GS} = 10 \ V)$

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	40	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	I _D	30	A
Drain peak current	I _{D(pulse)} Note1	120	A
Body-drain diode reverse drain current	I _{DR}	30	A
Avalanche current	I _{AP} Note 3	20	A
Avalanche energy	E _{AR} Note 3	32	mJ
Channel dissipation	Pch Note2	20	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Tc = 25°C

3. Value at Tch = 25°C, Rg \geq 50 Ω

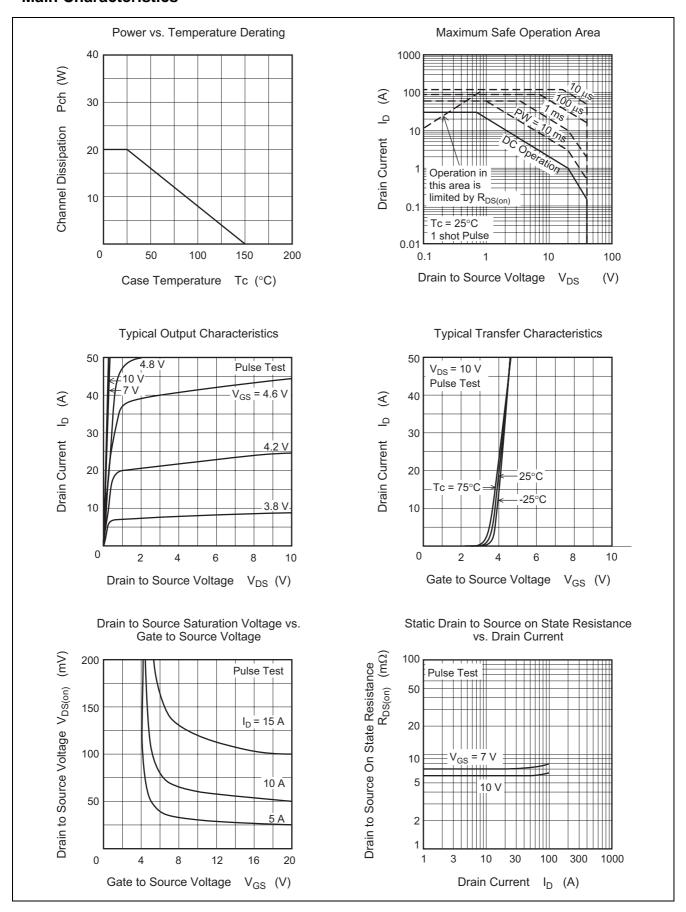
Electrical Characteristics

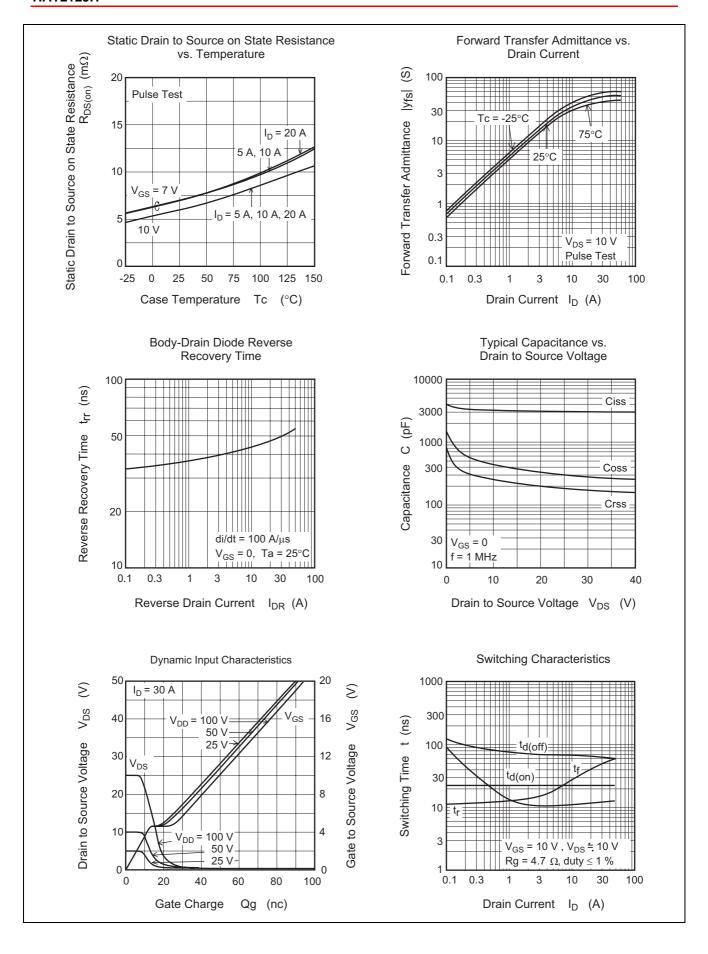
 $(Ta = 25^{\circ}C)$

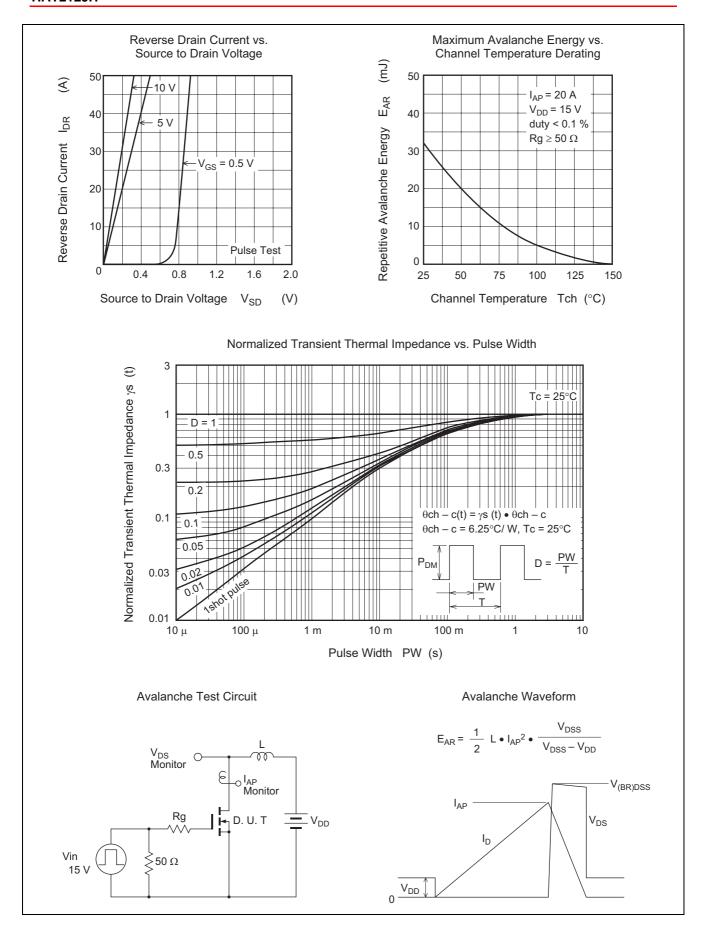
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V _{(BR)DSS}	40	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	_	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}		_	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 40 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	2.0	_	3.5	V	$V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$
Static drain to source on state	R _{DS(on)}	_	6.0	7.5	mΩ	$I_D = 15 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note4}}$
resistance	R _{DS(on)}	_	7.0	9.5	mΩ	$I_D = 15 \text{ A}, V_{GS} = 7 \text{ V}^{\text{Note4}}$
Forward transfer admittance	y _{fs}	24	40	_	S	$I_D = 15 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$
Input capacitance	Ciss	_	3200	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$
Output capacitance	Coss	_	450	_	pF	
Reverse transfer capacitance	Crss	_	260	_	pF	
Total gate charge	Qg	_	46	_	nC	$V_{DD} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}$
Gate to source charge	Qgs	_	13.5	_	nC	
Gate to drain charge	Qgd	_	7.5	_	nC	
Turn-on delay time	t _{d(on)}	_	22	_	ns	$V_{GS} = 10 \text{ V}, I_D = 15 \text{ A},$
Rise time	t _r	_	33	_	ns	$V_{DD} \cong 10 \text{ V}, R_L = 0.67 \Omega,$
Turn-off delay time	t _{d(off)}	_	67	_	ns	$Rg = 4.7 \Omega$
Fall time	t _f	_	11	_	ns	
Body-drain diode forward voltage	V_{DF}	_	0.84	1.10	V	$IF = 30 A$, $V_{GS} = 0$ Note4
Body-drain diode reverse	t _{rr}	_	50	_	ns	IF = 30 A, V _{GS} = 0
recovery time						$di_F/dt = 50 A/\mu s$

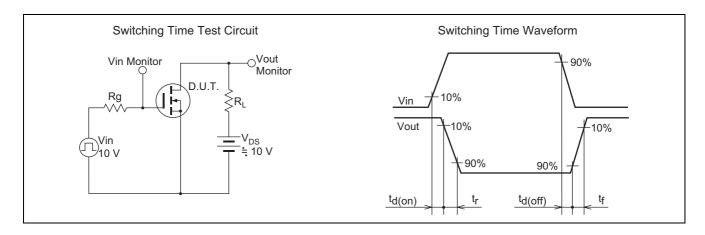
Notes: 4. Pulse test

Main Characteristics

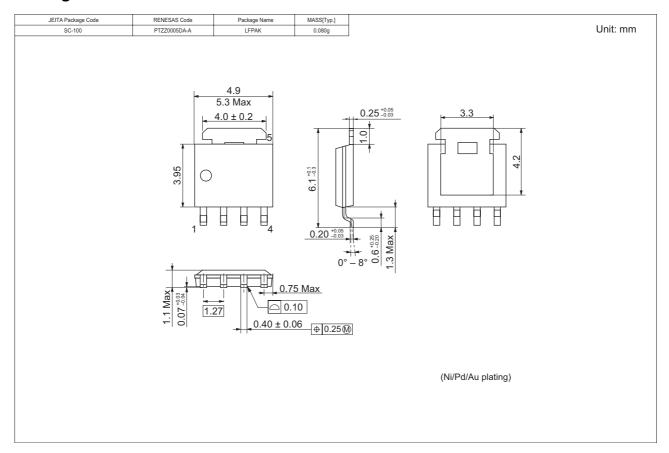








Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
HAT2129H-EL-E	2500 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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